

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

High-capacitance: Class 2, X5R/X7R
(Pb Free & RoHS compliant)

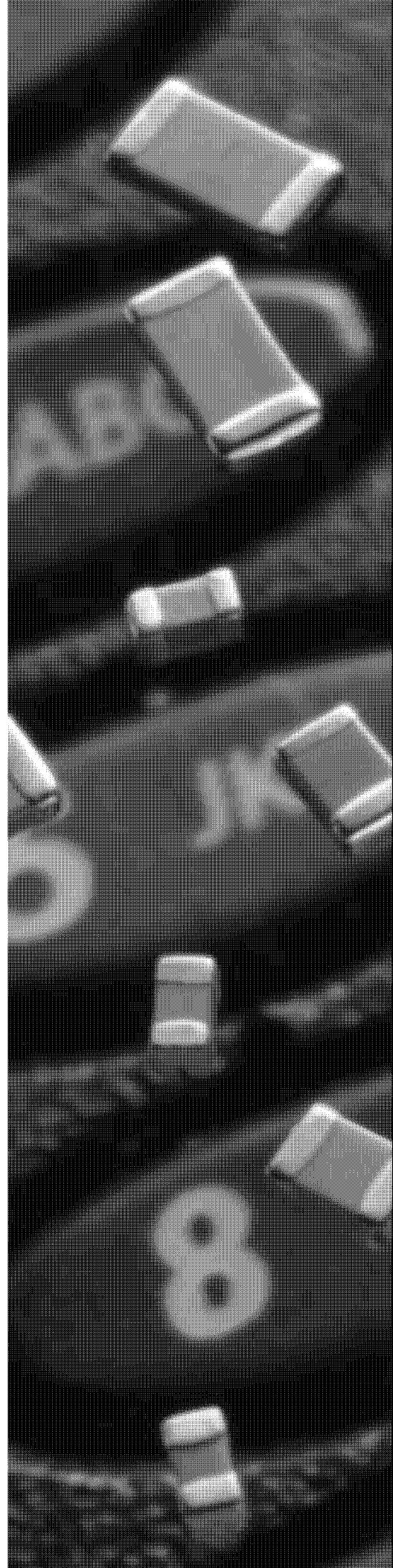
6.3 V TO 25 V

56 nF to 47 μ F



Phicomp

Product specification – Feb 18, 2005 V.10



SCOPE

This specification describes high capacitance X5R/X7R series chip capacitors with lead-free terminations.

APPLICATIONS

- PCs, hard disk, game PCs
- Power supplies
- DVDs, camcorders
- Mobile phones, PDAs

FEATURES

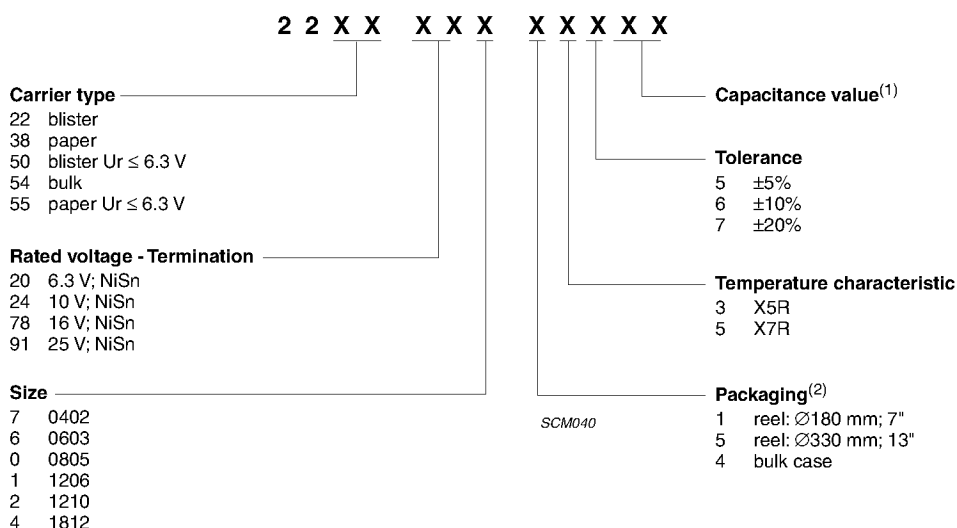
- Supplied in tape on reel
- Nickel-barrier end termination

ORDERING INFORMATION

Components may be ordered by using either a Phycomp's unique I2NC or Phycomp clear text code.

PHYCOMP ORDERING CODE

I2NC CODE



(1) Refer to "Conversion table of capacitance & last 2 digits of I2NC"

(2) Quantity on reel depends on thickness classification; see section "Thickness classification and packing quantities for 6.3 V to 25 V".

Conversion table of capacitance & last 2 digits of I2NC

CAP. (nF)	LAST 2 DIGITS OF I2NC	CAP. (nF)	LAST 2 DIGITS OF I2NC	CAP. (nF)	LAST 2 DIGITS OF I2NC	CAP. (nF)	LAST 2 DIGITS OF I2NC
0.10	09	1.8	26	33	43	560	59
0.12	11	2.2	27	39	44	680	61
0.15	12	2.7	28	47	45	820	62
0.18	13	3.3	29	56	46	1,000	63
0.22	14	3.9	31	68	47	1,500	65
0.27	15	4.7	32	82	48	2,200	67
0.33	16	5.6	33	100	49	3,300	69
0.39	17	6.8	34	120	51	4,700	72
0.47	18	8.2	35	150	52	6,800	74
0.56	19	10	36	180	53	10,000	76
0.68	21	12	37	220	54	22,000	81
0.82	22	15	38	270	55	47,000	85
1.0	23	18	39	330	56	100,000	89
1.2	24	22	41	390	57		
1.5	25	27	42	470	58		

NOTE

1. This table is applied to all X5R, X7R, Y5V, and Z5U products except Y5V 50 V products.

CTC CODE

Size code	Temp. Char.	Capacitance	Tolerance	Rated voltage	Termination	Packing	Marking	Series
0402	2B = X5R	225 = 2,200,000 pF; the	J = $\pm 5\%$	5 = 6.3 V	B = NiSn	2 = 180 mm; 7" paper	0 = No marking	D = BNE
0603	2R = X7R	third digit signifies the	K = $\pm 10\%$	6 = 10 V		3 = 330 mm; 13" paper		
0805		multiplying factor:	M = $\pm 20\%$	7 = 16 V		B = 180 mm; 7" blister		
1206		3 = $\times 1,000$		8 = 25 V		F = 330 mm; 13" blister		
1210		4 = $\times 10,000$				P = Bulk case		
1812		5 = $\times 100,000$						
		6 = $\times 1,000,000$						
		7 = $\times 10,000,000$						

Example: 06032B225M5B20D

CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.

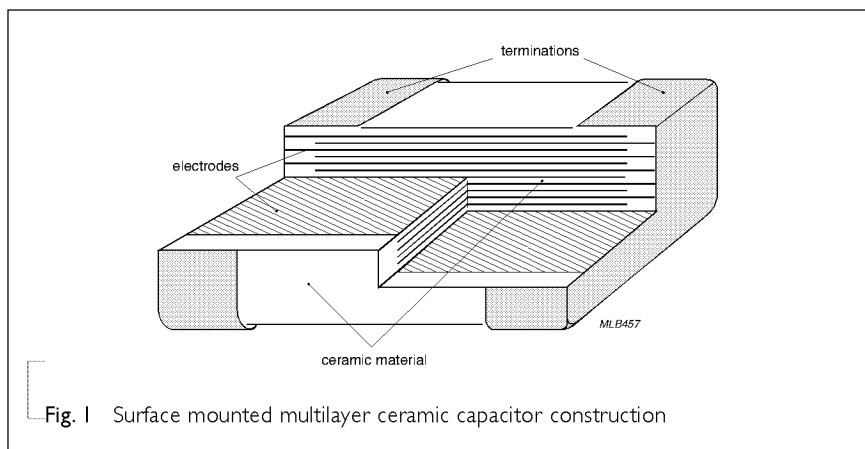


Fig. 1 Surface mounted multilayer ceramic capacitor construction

DIMENSION

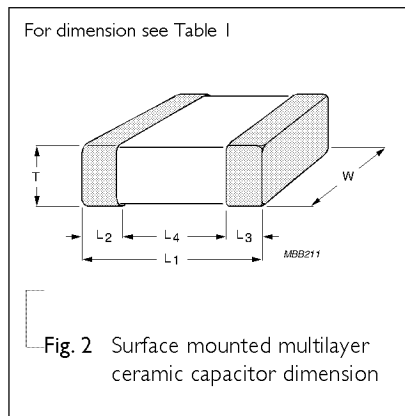


Fig. 2 Surface mounted multilayer ceramic capacitor dimension

Table I

TYPE	CC0402	CC0603	CC0805	CC1206	CC1210	CC1812
L_1 (mm)	1.0 ± 0.05	1.6 ± 0.10	2.0 ± 0.20	3.2 ± 0.20	3.2 ± 0.20	4.5 ± 0.20
W (mm)	0.5 ± 0.05	0.8 ± 0.07	1.25 ± 0.20	1.6 ± 0.20	2.5 ± 0.20	3.2 ± 0.20
T (mm)	Refer to table 2 to 4					
L_2/L_3 (mm)	min. 0.15	0.20	0.25	0.25	0.25	0.25
(mm)	max. 0.30	0.50	0.75	0.75	0.75	0.75
L_4 (mm)	min. 0.40	0.60	0.55	1.40	1.40	2.20

CAPACITANCE RANGE & THICKNESS FOR X5R/X7R 6.3 V

Table 2

CAPACITANCE (μF)	6.3 V 0402	0603	0805	1206	1210
0.056					
0.068					
0.082					
0.10	0.5 ±0.05				
0.12					
0.15					
0.18					
0.22					
0.27					
0.33					
0.39					
0.47					
0.56					
0.68					
0.82					
1.0		0.8 ±0.07			
1.5		0.8 ±0.1			
2.2			1.25 ±0.1		
3.3			1.25 ±0.2		
4.7					
6.8					
10				1.6 ±0.2	
22					2.5 ±0.2
47					

NOTE

- Values in shaded cells indicate thickness class in mm.
- X5R: ; X7R: ; both X5R and X7R: .

CAPACITANCE RANGE & THICKNESS FOR X5R/X7R 10V

Table 3

CAPACITANCE (μF)	10 V 0402	0603	0805	1206	1210
0.056	0.5 $\pm$ 0.05				
0.068					
0.082					
0.10	0.5 $\pm$ 0.05				
0.12	0.5 $\pm$ 0.05				
0.15					
0.18					
0.22					
0.27		0.8 $\pm$ 0.07			
0.33					
0.39					
0.47					
0.56		0.8 $\pm$ 0.07			
0.68					
0.82					
1.0			1.25 $\pm$ 0.1		
1.5		0.8 $\pm$ 0.1			
2.2			1.25 $\pm$ 0.1		
3.3			1.25 $\pm$ 0.2		
4.7				1.4 $\pm$ 0.2	
6.8				1.6 $\pm$ 0.2	
10					1.9 $\pm$ 0.2
22					2.5 $\pm$ 0.2

NOTE

- Values in shaded cells indicate thickness class in mm.
- X5R: ; X7R: ; both X5R and X7R: .

CAPACITANCE RANGE & THICKNESS FOR X5R/X7R 16V TO 25V

Table 4

CAPACITANCE (μF)	16V 0402	0603	0805	1206	1210	1812	25V 0603	1206	1210
0.056	0.5 ±0.05								
0.068									
0.082									
0.10									
0.12		0.8 ±0.07							
0.15									
0.18									
0.22									
0.27									
0.33							0.8 ±0.07		
0.39									
0.47									
0.56			1.25 ±0.2						
0.68									
0.82									
1.0								1.6 ±0.2	
1.5									
2.2				1.15 ±0.1					
3.3					1.9 ±0.2				1.9 ±0.2
4.7				1.6 ±0.2	1.9 ±0.2				
6.8					2.5 ±0.2				2.5 ±0.2
10									
22						2.5 ±0.2			

NOTE

- Values in shaded cells indicate thickness class in mm.
- X5R: ; X7R: ; both X5R and X7R: .

THICKNESS CLASSES AND PACKING QUANTITY
Table 5

DESCRIPTION	SIZE CODE	THICKNESS CLASSIFICATION (mm)	8 mm TAPE WIDTH/AMOUNT PER REEL				12 mm TAPE WIDTH /AMOUNT PER REEL	AMOUNT PER BULK CASE	
			Ø180 mm, 7"		Ø330 mm, 13"		Ø180 mm, 7" Blister		
			Paper	Blister	Paper	Blister			
Discrete capacitors	0201	0.3 ±0.03	15,000	---	50,000	---	---	---	
	0402	0.5 ±0.05	10,000	---	50,000	---	---	50,000	
	0603	0.8 ±0.07	4,000	---	15,000	---	---	15,000	
	0805	0.6 ±0.10	4,000	---	20,000	---	---	10,000	
	1206	0.85 ±0.1	4,000	---	15,000	---	---	8,000	
		1.25 ±0.10	---	3,000	---	10,000	---	5,000	
		0.6 ±0.10	4,000	---	20,000	---	---	---	
		0.85 ±0.10	4,000	---	15,000	---	---	---	
		1.00 / 1.15 ±0.10	---	3,000	---	10,000	---	---	
	1210	1.6 ±0.15	---	2 500	---	10,000	---	---	
		1.6 ±0.20	---	2,000	---	10,000	---	---	
		0.6 / 0.7 ±0.10	---	4,000	---	15,000	---	---	
		0.85 ±0.10	---	4,000	---	10,000	---	---	
		1.15 ±0.10	---	3,000	---	10,000	---	---	
	1808	1.15 ±0.15	---	3,000	---	10,000	---	---	
		1.5 ±0.10	---	2,000	---	---	---	---	
		1.6 / 1.9 ±0.20	---	2,000	---	---	---	---	
		2.5 ±0.20	---	1,000	---	---	---	---	
		1.15 ±0.15	---	---	---	---	1 500	---	
	1812	1.35 ±0.15	---	---	---	---	1,000	---	
		1.5 ±0.10	---	---	---	---	1,000	---	
		0.6 / 0.85 ±0.10	---	---	---	---	2,000	---	
		1.15 ±0.10	---	---	---	---	1,500	---	
		1.15 ±0.15	---	---	---	---	1,500	---	
	Low inductance	0306	0.5 ±0.10	4,000	---	15,000	---	---	---
		0508	0.85 ±0.10	4,000	---	15,000	---	---	---
		0612	0.85 ±0.10	4,000	---	15,000	---	---	---
0508		0.6 ±0.10	4,000	---	---	---	---	---	
Arrays	0612	0.85 ±0.10	4,000	---	---	---	---	---	
		0.8 ±0.10	4,000	---	---	---	---	---	
		1.2 ±0.10	---	3,000	---	---	---	---	

ELECTRICAL CHARACTERISTICS

CLASS 2 CAPACITORS; X5R/X7R DIELECTRIC; NISN TERMINATIONS

Unless otherwise stated all electrical values apply at an ambient temperature of 20 ± 1 °C, an atmospheric pressure of 86 to 106 kPa, and a relative humidity of 63 to 67%.

Table 6

DESCRIPTION	VALUE
Capacitance range ⁽¹⁾	56 nF to 47 µF
Capacitance tolerance ^{(1) (2)}	±5%, ±10%, and ±20%
Dissipation factor (D.F.) ⁽¹⁾	See table 7 - 12
Insulation resistance after 1 minute at U_r (DC)	$R_{ins} \geq 10 \text{ G}\Omega$ or $R_{ins} \times C \geq 500$ seconds whichever is less
Maximum capacitance change as a function of temperature (temperature characteristic/coefficient)	±15%
Operating temperature range:	
X5R	−55 °C to +85 °C
X7R	−55 °C to +125 °C

NOTE

1. $f=1 \text{ KHz}$ for $C \leq 10 \text{ }\mu\text{F}$; measuring at voltage $1 \text{ }V_{rms}$; $f=120 \text{ Hz}$ for $C > 10 \text{ }\mu\text{F}$; measuring at voltage $0.5 \text{ }V_{rms}$.
2. ±5% capacitance tolerance is on request for capacitance value $< 1 \text{ }\mu\text{F}$.

DISSIPATION FACTOR (D.F.) FOR SIZES 0402 TO 1812
Table 7 For size 0402 (1005 metric)

TC	SIZE	CAPACITANCE VALUE (μF)	CAPACITANCE TOLERANCE (%)	DC RATED VOLTAGE (V)	DISSIPATION FACTOR- D.F. (%)	THICKNESS (mm)
X5R	0402	0.10	±10; ±20	6.3	7.0	0.50
X5R	0402	0.12	±10; ±20	6.3	7.0	0.50
X5R	0402	0.15	±10; ±20	6.3	7.0	0.50
X5R	0402	0.18	±10; ±20	6.3	7.0	0.50
X5R	0402	0.22	±10; ±20	6.3	7.0	0.50
X5R	0402	0.27	±10; ±20	6.3	10.0	0.50
X5R	0402	0.33	±10; ±20	6.3	10.0	0.50
X5R	0402	0.39	±10; ±20	6.3	10.0	0.50
X5R	0402	0.47	±10; ±20	6.3	10.0	0.50
X5R	0402	0.56	±10; ±20	6.3	10.0	0.50
X5R	0402	0.68	±10; ±20	6.3	10.0	0.50
X5R	0402	0.82	±10; ±20	6.3	10.0	0.50
X5R	0402	1.00	±10; ±20	6.3	10.0	0.50
X7R	0402	0.056	±10; ±20	10	5.0	0.50
X7R	0402	0.068	±10; ±20	10	5.0	0.50
X7R	0402	0.082	±10; ±20	10	5.0	0.50
X5R	0402	0.10	±10; ±20	10	5.0	0.50
X7R	0402	0.10	±10; ±20	10	5.0	0.50
X5R	0402	0.12	±10; ±20	10	7.0	0.50
X5R	0402	0.15	±10; ±20	10	7.0	0.50
X5R	0402	0.18	±10; ±20	10	7.0	0.50
X5R	0402	0.22	±10; ±20	10	7.0	0.50
X5R	0402	0.056	±10; ±20	16	5.0	0.50
X7R	0402	0.056	±10; ±20	16	5.0	0.50
X5R	0402	0.068	±10; ±20	16	5.0	0.50
X7R	0402	0.068	±10; ±20	16	5.0	0.50
X5R	0402	0.082	±10; ±20	16	5.0	0.50
X7R	0402	0.082	±10; ±20	16	5.0	0.50
X5R	0402	0.10	±10; ±20	16	5.0	0.50
X7R	0402	0.10	±10; ±20	16	5.0	0.50

Table 8 For size 0603 (1608 metric)

TC	SIZE	CAPACITANCE VALUE (μF)	CAPACITANCE TOLERANCE (%)	DC RATED VOLTAGE (V)	DISSIPATION FACTOR- D.F. (%)	THICKNESS (mm)
X5R	0603	1.00	±10; ±20	6.3	7.0	0.80
X5R	0603	1.50	±10; ±20	6.3	10.0	0.80
X5R	0603	2.20	±10; ±20	6.3	10.0	0.80
X5R	0603	3.30	±10; ±20	6.3	10.0	0.80
X5R	0603	4.70	±20	6.3	10.0	0.80
X7R	0603	0.27	±10; ±20	10	5.0	0.80
X7R	0603	0.33	±10; ±20	10	5.0	0.80
X7R	0603	0.39	±10; ±20	10	5.0	0.80
X7R	0603	0.47	±10; ±20	10	5.0	0.80
X5R	0603	0.56	±10; ±20	10	7.0	0.80
X5R	0603	0.68	±10; ±20	10	7.0	0.80
X5R	0603	0.82	±10; ±20	10	7.0	0.80
X5R	0603	1.00	±10; ±20	10	7.0	0.80
X5R	0603	1.50	±10; ±20	10	7.0	0.80
X5R	0603	2.20	±10; ±20	10	10.0	0.80
X7R	0603	0.12	±10; ±20	16	5.0	0.80
X7R	0603	0.15	±10; ±20	16	5.0	0.80
X7R	0603	0.18	±10; ±20	16	5.0	0.80
X7R	0603	0.22	±10; ±20	16	5.0	0.80
X7R	0603	0.27	±10; ±20	16	5.0	0.80
X7R	0603	0.33	±10; ±20	16	5.0	0.80
X7R	0603	0.39	±10; ±20	16	5.0	0.80
X7R	0603	0.47	±10; ±20	16	5.0	0.80
X5R	0603	0.33	±10; ±20	25	5.0	0.80
X5R	0603	0.39	±10; ±20	25	5.0	0.80
X5R	0603	0.47	±10; ±20	25	5.0	0.80

Table 9 For size 0805 (2012 metric)

TC	SIZE	CAPACITANCE VALUE (μF)	CAPACITANCE TOLERANCE (%)	DC RATED VOLTAGE (V)	DISSIPATION FACTOR- D.F. (%)	THICKNESS (mm)
X5R	0805	2.20	±10; ±20	6.3	7.0	1.25
X7R	0805	2.20	±10; ±20	6.3	7.0	1.25
X5R	0805	3.30	±10; ±20	6.3	7.0	1.25
X5R	0805	4.70	±10; ±20	6.3	7.0	1.25
X5R	0805	6.80	±10; ±20	6.3	10.0	1.25
X5R	0805	10.00	±10; ±20	6.3	10.0	1.25
X7R	0805	1.00	±10; ±20	10	5.0	1.25
X7R	0805	1.50	±10; ±20	10	7.0	1.25
X5R	0805	2.20	±10; ±20	10	7.0	1.25
X7R	0805	2.20	±10; ±20	10	7.0	1.25
X5R	0805	3.30	±10; ±20	10	7.0	1.25
X5R	0805	4.70	±10; ±20	10	7.0	1.25
X5R	0805	6.80	±10; ±20	10	10.0	1.25
X5R	0805	10.00	±10; ±20	10	10.0	1.25
X7R	0805	0.56	±10; ±20	16	5.0	1.25
X7R	0805	0.68	±10; ±20	16	5.0	1.25
X7R	0805	0.82	±10; ±20	16	5.0	1.25
X7R	0805	1.00	±10; ±20	16	5.0	1.25

Table 10 For size 1206 (3216 metric)

TC	SIZE	CAPACITANCE VALUE (μF)	CAPACITANCE TOLERANCE (%)	DC RATED VOLTAGE (V)	DISSIPATION FACTOR- D.F. (%)	THICKNESS (mm)
X5R	1206	10.00	±10; ±20	6.3	7.5	1.60
X5R	1206	22.00	±10; ±20	6.3	10.0	1.60
X5R	1206	4.70	±10; ±20	10	5.0	1.60
X7R	1206	4.70	±10; ±20	10	5.0	1.60
X5R	1206	6.80	±10; ±20	10	7.5	1.60
X5R	1206	10.00	±10; ±20	10	7.5	1.60
X7R	1206	2.20	±10; ±20	16	5.0	1.15
X5R	1206	4.70	±10; ±20	16	5.0	1.60
X7R	1206	1.00	±10; ±20	25	7.5	1.60

Table 11 For size 1210 (3225 metric)

TC	SIZE	CAPACITANCE VALUE (μF)	CAPACITANCE TOLERANCE (%)	DC RATED VOLTAGE (V)	DISSIPATION FACTOR- D.F. (%)	THICKNESS (mm)
X5R	1210	22.00	±20	6.3	2.5	2.50
X5R	1210	47.00	±20	6.3	10.0	2.50
X5R	1210	10.00	±10; ±20	10	3.5	1.90
X5R	1210	22.00	±20	10	7.0	2.50
X5R	1210	3.30	±10; ±20	16	3.5	1.90
X5R	1210	4.70	±10; ±20	16	3.5	1.90
X7R	1210	4.70	±10; ±20	16	3.5	1.90
X5R	1210	6.80	±10; ±20	16	3.5	2.50
X5R	1210	10.00	±10; ±20	16	3.5	2.50
X5R	1210	3.30	±10; ±20	25	3.5	1.90
X5R	1210	4.70	±10; ±20	25	3.5	1.90
X5R	1210	6.80	±10; ±20	25	2.5	2.50
X5R	1210	10.00	±10; ±20	25	2.5	2.50

Table 12 For size 1812 (4532 metric)

TC	SIZE	CAPACITANCE VALUE (μF)	CAPACITANCE TOLERANCE (%)	DC RATED VOLTAGE (V)	DISSIPATION FACTOR- D.F. (%)	THICKNESS (mm)
X5R	1812	22.00	±10; ±20	16	3.5	2.50

SOLDERING RECOMMENDATION

Table 13

SOLDERING METHOD	SIZE				
	0402	0603	0805	1206	≥ 1210
Reflow	≥ 0.1 μF	≥ 1.0 μF	≥ 2.2 μF	≥ 4.7 μF	Reflow only
Reflow/Wave	< 0.1 μF	< 1.0 μF	< 2.2 μF	< 4.7 μF	---

TESTS AND REQUIREMENTS

Table 14 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384-22 4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual inspection and dimension check	4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance	4.5.1	Precondition: 150 +0/−10 °C for 1 hour, then keep for 48 ± 1 hours at room temperature f = 1 kHz for C ≤ 10 μF: measuring voltage 1 V _{rms} at 20 °C f = 120 Hz for C > 10 μF: measuring voltage 0.5 V _{rms} at 20 °C	Within specified tolerance
Dissipation factor (D.F.)	4.5.2	f = 1 kHz for C ≤ 10 μF: measuring voltage 1 V _{rms} at 20 °C f = 120 Hz for C > 10 μF: measuring voltage 0.5 V _{rms} at 20 °C	In accordance with specification
Insulation resistance	4.5.3	At U _r (DC) for 1 minute	In accordance with specification
Voltage proof	4.5.4.2	2.5 × U _r for 1 minute	No breakdown or flashover
Temperature characteristic	4.6	Between minimum and maximum temperature	In accordance with specification
Adhesion	4.15	A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate for size ≥ 0603: a force of 5 N applied for size 0402: a force of 2.5 N applied	No visible damage
Bond strength of plating on end face	4.8	Mounting in accordance with IEC 60384-22 paragraph 4.3 Conditions: bending 1 mm at a rate of 1 mm/s, radius jig 340 mm	No visible damage X5R/X7R: ΔC/Ci ≤ 10% Y5V: ΔC/Ci ≤ 20%

Table 14 Test condition, procedure and requirements (continued)

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Resistance to soldering heat	4.9	Precondition: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature Preheating: for size ≤ 1206: 120 to 150 °C for 1 minute Preheating: for size > 1206: 100 to 120 °C for 1 minute and 170 to 200 °C for 1 minute Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours.	The termination shall be well tinned X5R/X7R: $\Delta C/C_i \leq 10\%$ Y5V: $\Delta C/C_i \leq 20\%$ D.F.: within initial specified value R_{ins}: within initial specified value
Solderability	4.10	Unmounted chips completely immersed in a solder bath at 235 ±5 °C Dipping time: size ≤ 1206 for 2 ±0.5 seconds; size > 1206 for 4 ±0.5 seconds	The termination shall be well tinned.
Rapid change of temperature	IEC 60384-22 4.11	Preconditioning: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature 5 cycles with following detail: 30 minutes at lower category temperature; 30 minutes at upper category temperature Recovery time 24 ±2 hours.	No visual damage X5R/X7R: $\leq 15\%$ Y5V: $\leq 20\%$ D.F.: within initial specified value R_{ins}: within initial specified value
Damp heat steady state	4.13	Initial measurements; after 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature Duration and conditions: 500 ±12 hours at 40 ±2 °C; 90 to 95% RH Final measurement: perform a heat treatment at 150 +0/-10 °C for 1 hour, final measurements shall be carried out 24 ±1 hours after recovery at room temperature without load.	X5R/X7R: $\Delta C/C_i \pm 20\%$ Y5V: $\Delta C/C_i \pm 30\%$ D.F.: 2 × initial value max. R_{ins}: 1,000 MΩ or R_{ins} × C_r ≥ 50 seconds, whichever is less
Endurance	4.14	Preconditioning: Initial measurements; after 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature Duration and conditions: 1,000 ±12 hours at upper category temperature with 1.5 × U_r voltage applied Final measurement: perform a heat treatment at 150 +0/-10 °C for 1 hour, final measurements shall be carried out 24 ±1 hours after recovery at room temperature without load.	X5R/X7R: $\Delta C/C_i \pm 20\%$ Y5V: $\Delta C/C_i \pm 30\%$ D.F.: 2 × initial value max. R_{ins}: 1,000 MΩ or R_{ins} × C_r ≥ 50 seconds, whichever is less

Table 14 Test condition, procedure and requirements (continued)

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Resistance to leaching	IEC 60384-10 4.10	Solder bath temperature: 260 ± 5 °C Dipping time 30 ± 0.5 seconds	Using visual enlargement of $\times 10$, dissolution of the termination shall not exceed 10%
Damp heat, with U_r load	4.14	Initial measurements; after $150 +0/-10$ °C for 1 hour, then keep for 24 ± 1 hours at room temperature Duration and conditions: 500 ± 12 hours at 40 ± 2 °C; 90 to 95% RH; U_r applied Final measurement: perform a heat treatment at $150 +0/-10$ °C for 1 hour, final measurements shall be carried out 24 ± 1 hours after recovery at room temperature without load.	X5R/X7R: $\Delta C/C_i$: $\pm 20\%$ Y5V: $\Delta C/C_i$: $\pm 30\%$ D.F.: $2 \times$ initial value max. R_{ins} : $500 M\Omega$ or $R_{ins} \times C_r \geq 25$ seconds, whichever is less

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 10	Feb 18, 2005	-	- Capacitance range extended
Version 9	Nov 17, 2004	-	- Extended capacitance 0.68 μ F and 2.2 μ F of X5R 0603 10 V
Version 8	Sep 29, 2004	-	- Revised I2NC ordering code of table 7-9
Version 7	Sep 20, 2004	-	- Rated voltage 6.3 V added to 0402/1210 and 25 V added to 1206 - Extend capacitance range: 4.7 μ F of 0603, 22 μ F of 1206, and 22 μ F of 1210
Version 6	Aug 13, 2004	-	- 0603 10 V 0.47 μ F extended material with X5R
Version 5	2004 Jul 06	-	- Revise the dimensions of 0603 and 0805
Version 4	2004 May 10	-	- Extended capacitance 4.7 μ F and 10 μ F of X5R 0805 10 V - Revised I2NC ordering code and Phycomp clear text code of table 2 & 3
Version 3	2004 Mar 02	-	- Test and requirement revised.
Version 2	2004 Feb 25	-	- Test and requirement revised.
Version 1	2003 Sep 16	-	- Updated company logos
Version 0	2002 Aug 16	-	-